查询2SA1121供应商

# 2SA1121

Silicon PNP Epitaxial

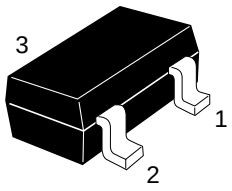
HITACHI

## Application

- Low frequency amplifier
- Complementary pair with 2SC2618

## Outline

MPAK




1. Emitter
2. Base
3. Collector

Hitachi semiconductor

## Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|---|---|---|---|
| Collector to base voltage | $V_{CBO}$ | –35 | V |
| Collector to emitter voltage | $V_{CEO}$ | –35 | V |
| Emitter to base voltage | $V_{EBO}$ | –4 | V |
| Collector current | $I_C$ | –500 | mA |
| Collector power dissipation | $P_C$ | 150 | mW |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | Tstg | –55 to +150 | °C |

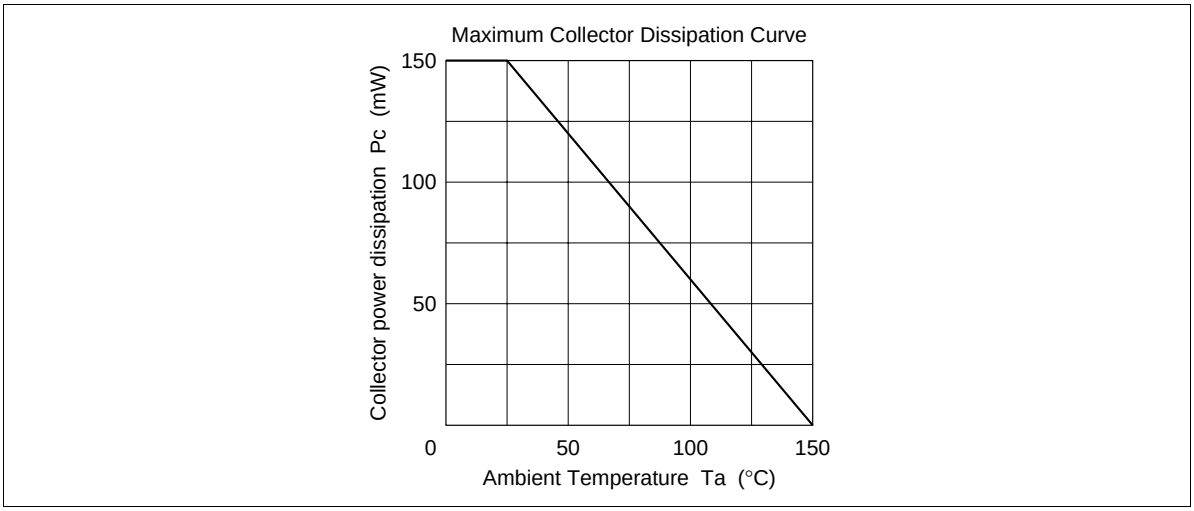
## Electrical Characteristics (Ta = 25°C)

| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|---|---|---|---|---|---|---|
| Collector to base breakdown voltage | $V_{(BR)CBO}$ | –35 | — | — | V | $I_C$ = –10 µA, $I_E$ = 0 |
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | –35 | — | — | V | $I_C$ = –1 mA, $R_{BE}$ = ∞ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | –4 | — | — | V | $I_E$ = –10 µA, $I_C$ = 0 |
| Collector cutoff current | $I_{CBO}$ | — | — | –0.5 | µA | $V_{CB}$ = –20 V, $I_E$ = 0 |
| Collector to emitter saturation voltage | $V_{CE(sat)}$ | — | –0.2 | –0.6 | V | $I_C$ = –150 mA, $I_B$ = –15 mA |
| DC current transfer ratio | $h_{FE}$*[1] | 60 | — | 320 | | $V_{CE}$ = –3 V, $I_C$ = –10 mA |
| | $h_{FE}$ | 10 | — | — | | $V_{CE}$ = –3 V, $I_C$ = –500 mA (Pulse test) |
| Base to emitter voltage | $V_{BE}$ | — | –0.64 | — | V | $V_{CE}$ = –3 V, $I_C$ = –10 mA |

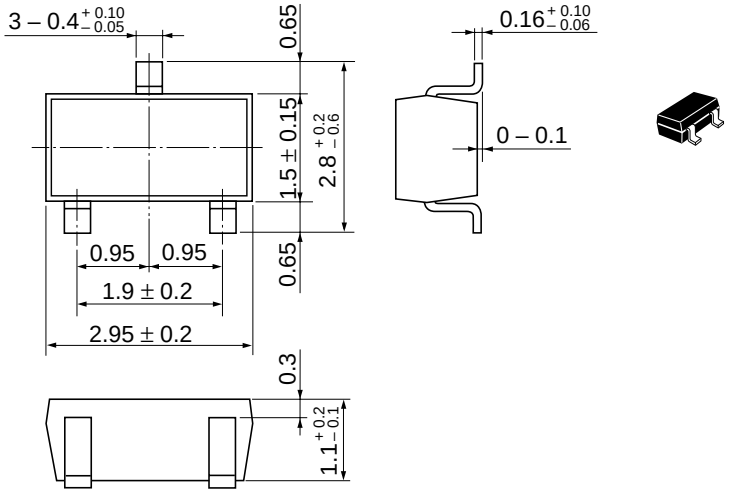
Note: 1. The 2SA1121 is grouped by $h_{FE}$ as follows.

| Grade | B | C | D |
|---|---|---|---|
| Mark | SB | SC | SD |
| $h_{FE}$ | 60 to 120 | 100 to 200 | 160 to 320 |

See characteristic curves of 2SA673.


Maximum Collector Dissipation Curve
Collector power dissipation Pc (mW)
150
100
50
0
50
100
150
Ambient Temperature Ta (°C)

Unit: mm




| | |
|---|---|
| Hitachi Code | MPAK |
| JEDEC | — |
| EIAJ | Conforms |
| Weight (reference value) | 0.011 g |

## Cautions

1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
5. This product is not designed to be radiation resistant.
6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

# HITACHI

**Hitachi, Ltd.**
Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL
NorthAmerica : http:semiconductor.hitachi.com/
Europe : http://www.hitachi-eu.com/hel/ecg
Asia (Singapore) : http://www.has.hitachi.com.sg/grp3/sicd/index.htm
Asia (Taiwan) : http://www.hitachi.com.tw/E/Product/SICD_Frame.htm
Asia (HongKong) : http://www.hitachi.com.hk/eng/bo/grp3/index.htm
Japan : http://www.hitachi.co.jp/Sicd/indx.htm

**For further information write to:**

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

Copyright ' Hitachi, Ltd., 1999. All rights reserved. Printed in Japan.